



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 1388**  
Akihisa HONGO et al. : Docket No. 2001-0924A  
Serial No. 09/891,472 : Group Art Unit 1742  
Filed June 27, 2001 : Examiner Donald R. Valentine

METHOD AND APPARATUS FOR  
FORMING INTERCONNECTS, AND  
POLISHING LIQUID AND POLISHING  
METHOD

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**NOV 25 2003**

**TC 1700**

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**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of July 18, 2003, the period for response to which having been extended by one month to November 18, 2003, kindly amend the above-referenced U.S. patent application as follows:

**AMENDMENTS TO THE TITLE**

**Please change the title of the invention as follows:**

~~METHOD AND APPARATUS FOR FORMING INTERCONNECTS, AND POLISHING LIQUID  
AND POLISHING METHOD~~